

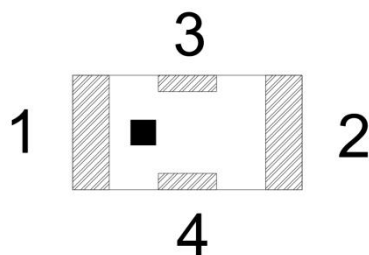
### Features

- Multilayer monolithic construction yields high reliability
- Low insertion loss and small size SMD chip design
- Can simplify your complex tuning and circuit design
- LTCC process

### Specifications

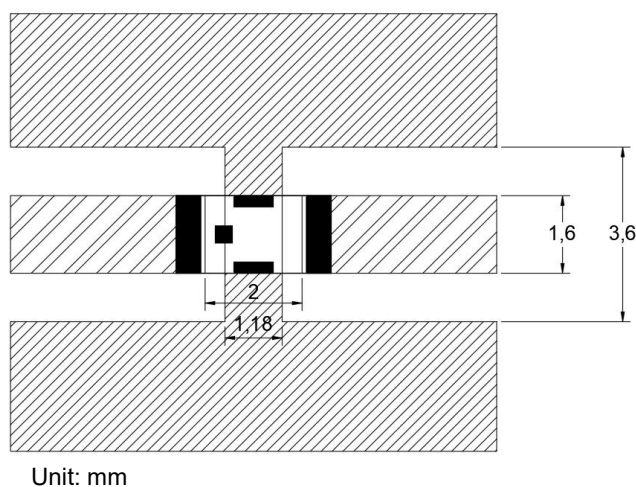
| NO.                                                                     | Parameter               |            | SPC       |
|-------------------------------------------------------------------------|-------------------------|------------|-----------|
| 1                                                                       | Frequency (MHz)         |            | 1300~1950 |
| 2                                                                       | Insertion Loss (dB)@25℃ |            | ≤1.5      |
| 3                                                                       | VSWR(In BW)             |            | ≤2.0      |
| 4                                                                       | Ripple (dB)             |            | ≤1.0 dB   |
| 5                                                                       | Attenuation             | DC~1000MHz | ≥30 dBc   |
|                                                                         |                         | 3250MHz    | ≥35dB     |
| 6                                                                       | In/Output Impedance (Ω) |            | 50        |
| 7                                                                       | Input Power             |            | 10W       |
| <b>Operating &amp; Storage Condition (Component)</b>                    |                         |            |           |
| Operation Temperature Range: -40℃ ~ +85℃                                |                         |            |           |
| Storage Temperature Range: -40℃~ +85℃                                   |                         |            |           |
| <b>Storage Condition before Soldering (Included packaging material)</b> |                         |            |           |
| Storage Temperature Range: +5 ~ +40 ℃                                   |                         |            |           |
| Humidity: 30 to 70% relative humidity                                   |                         |            |           |

### Construction

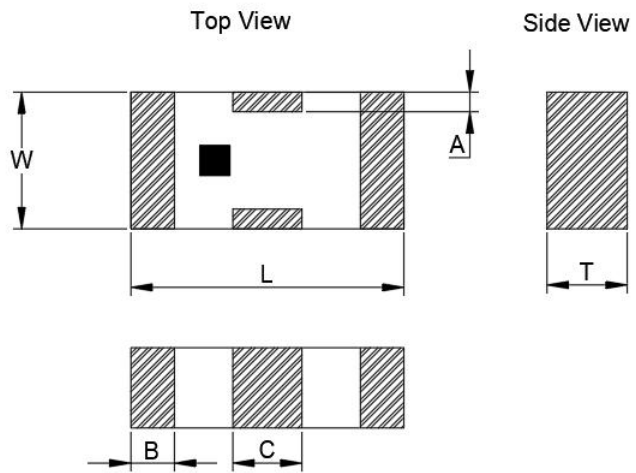


| PIN | Connection  |
|-----|-------------|
| 1   | Input Port  |
| 2   | Output Port |
| 3   | GND         |
| 4   | GND         |

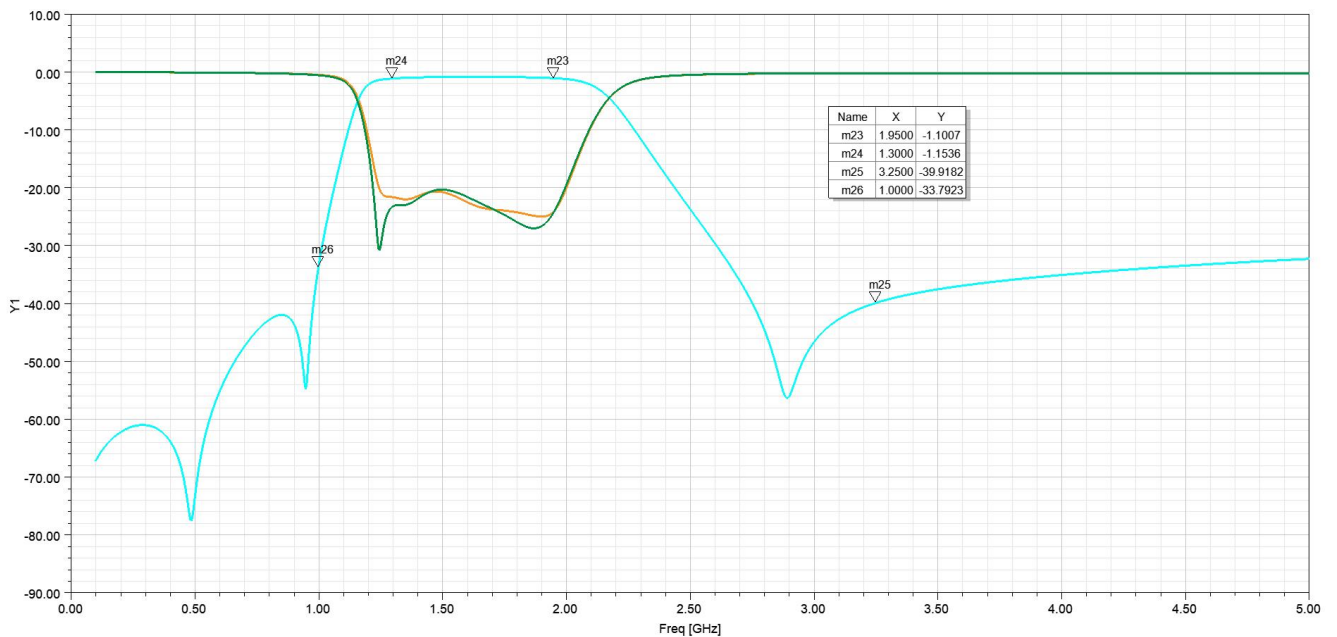
### Mounting Considerations



### Dimensions

| Figure                                                                             | Symbol | Dimension (mm)  |
|------------------------------------------------------------------------------------|--------|-----------------|
|  | L      | $3.20 \pm 0.20$ |
|                                                                                    | W      | $1.60 \pm 0.20$ |
|                                                                                    | T      | $0.94 \pm 0.20$ |
|                                                                                    | A      | $0.23 \pm 0.10$ |
|                                                                                    | B      | $0.51 \pm 0.10$ |
|                                                                                    | C      | $0.81 \pm 0.10$ |

### Typical Electrical Characteristics (T=25°C)



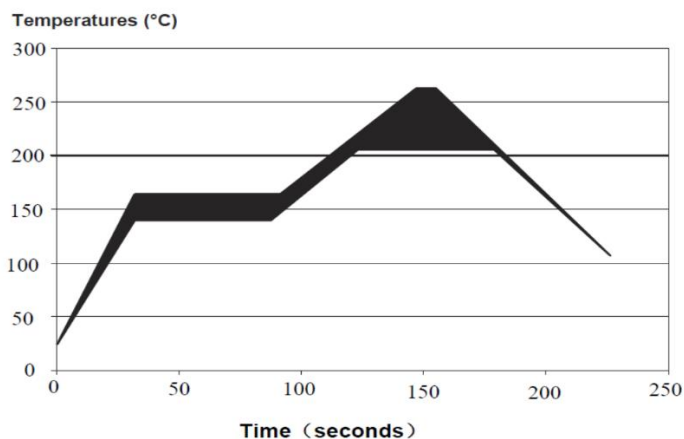
### Yantel Corporation

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For detailed performance specs & shopping online see Yantel web site : [www.yantel-corp.com](http://www.yantel-corp.com)

### Solder Reflow Standard Conditioning



### Storage Conditions

Temperature : +5 to +30 °C

Humidity : 20 to 70% RH

Term of storage : Within 12 months (After the delivery) \*

Baking : Unnecessary

\* After peeling off cover tape, do not keep exposing the products to the open air. For the products stored longer than 12 months, confirm their terminals and solderability before use.